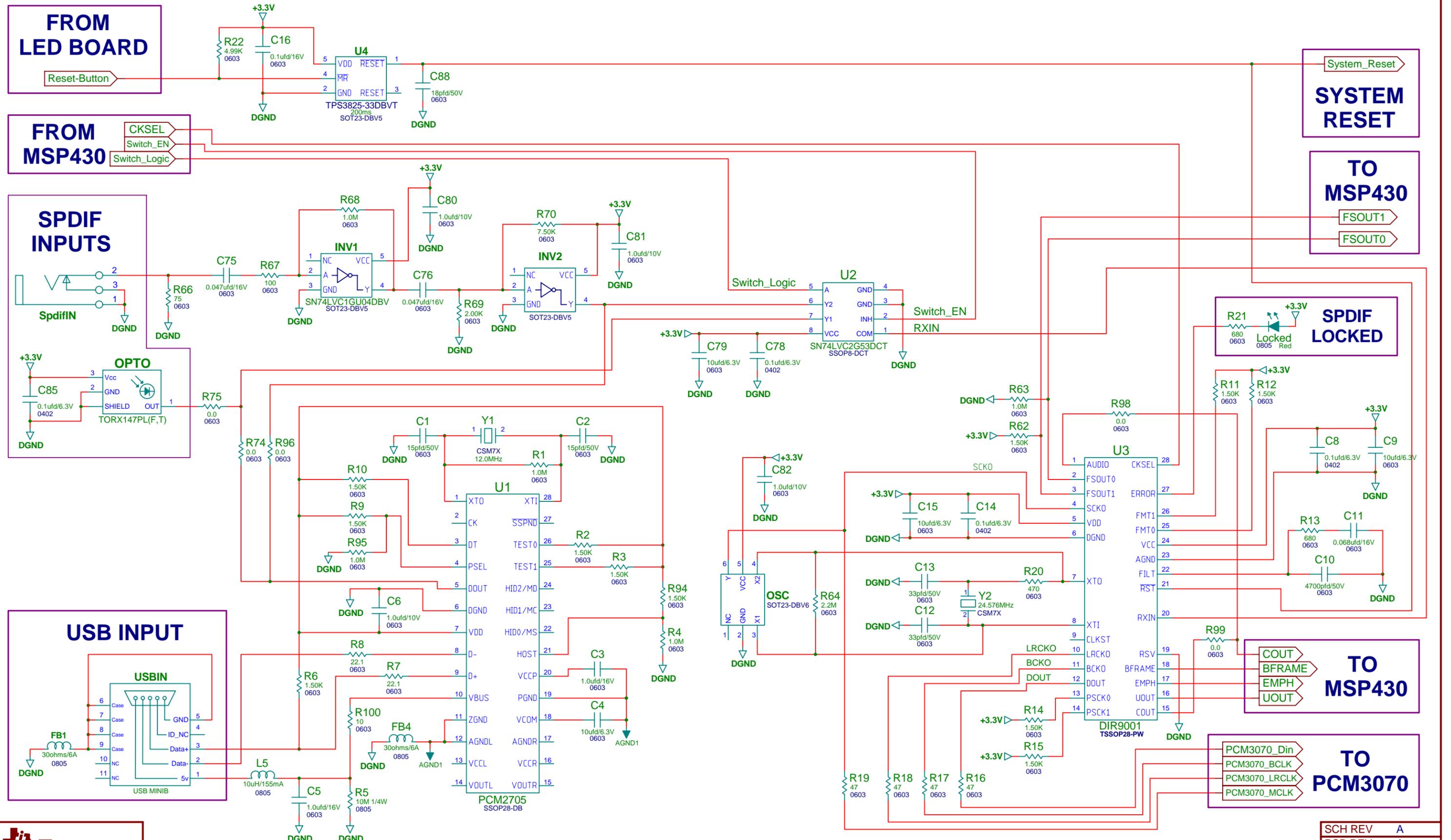
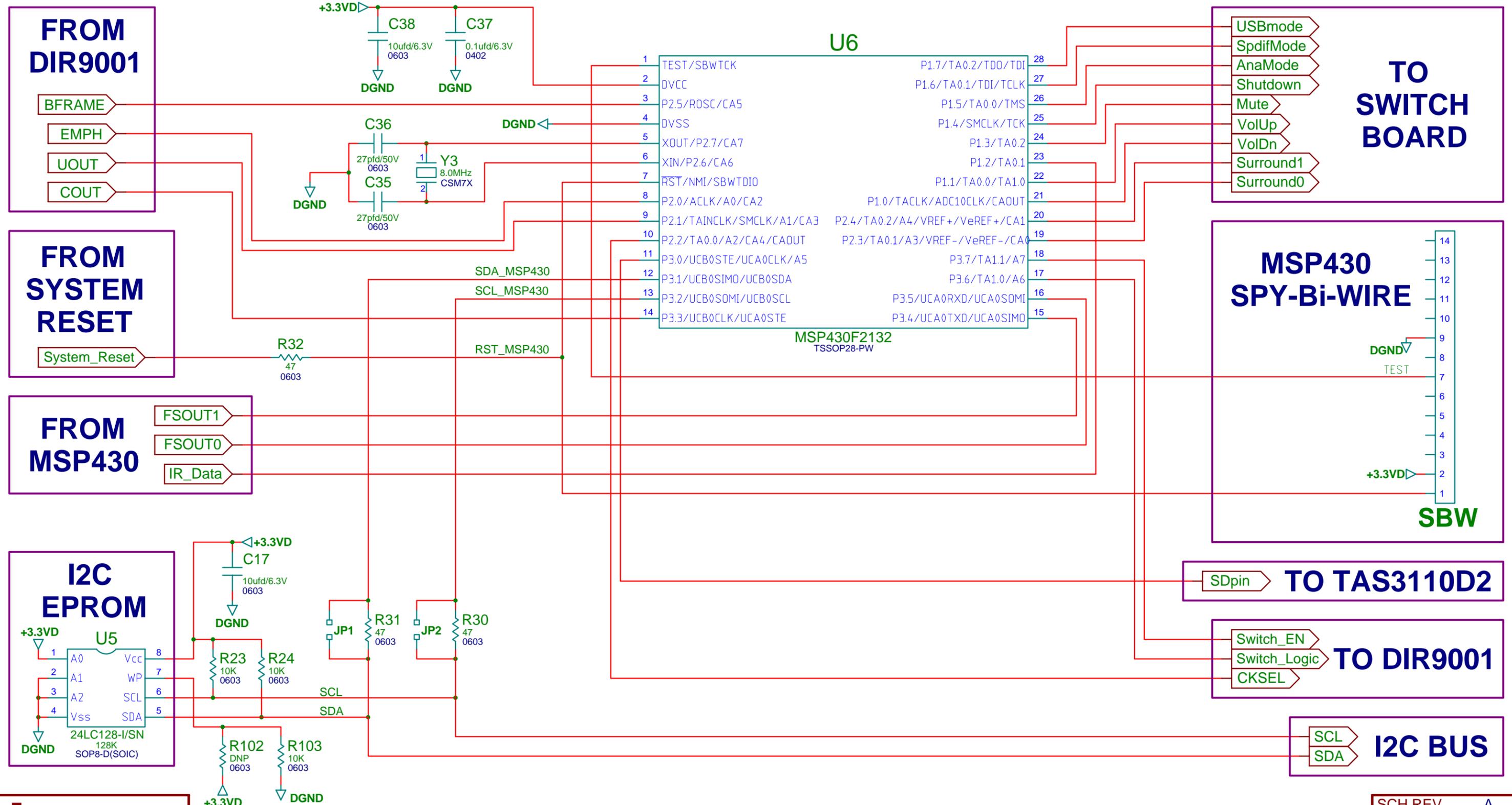


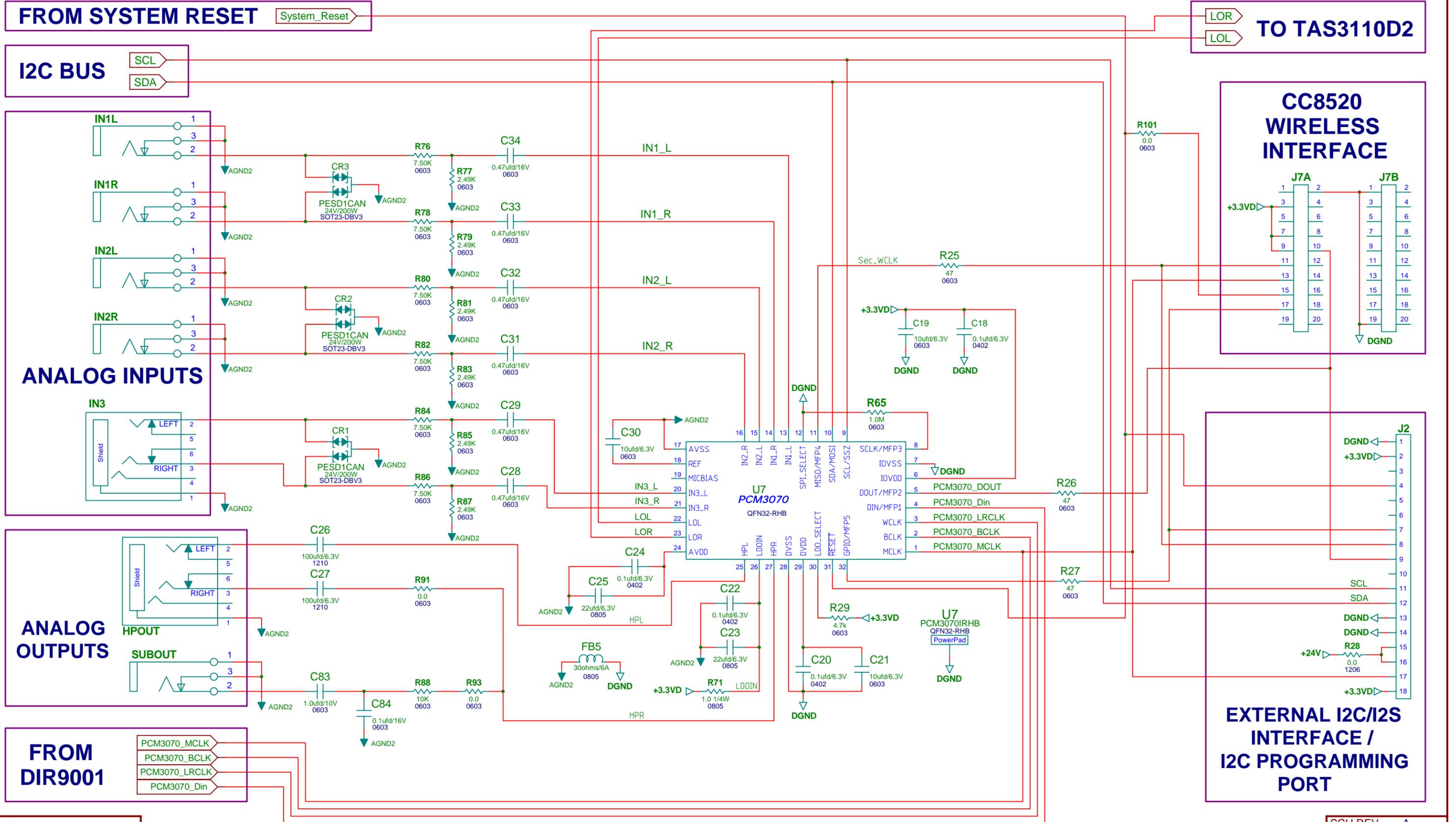
# RDK-Value-SB (RevA)



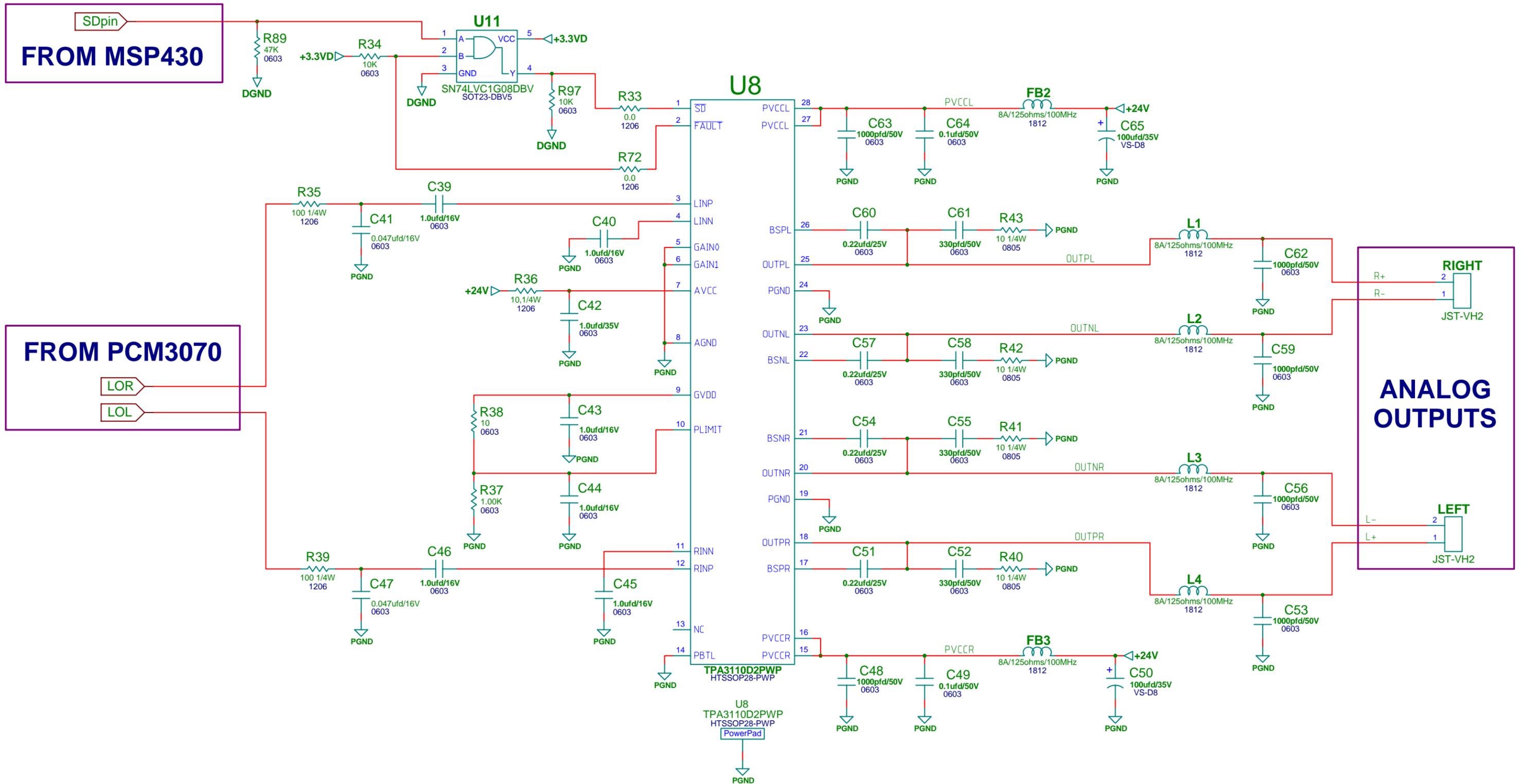
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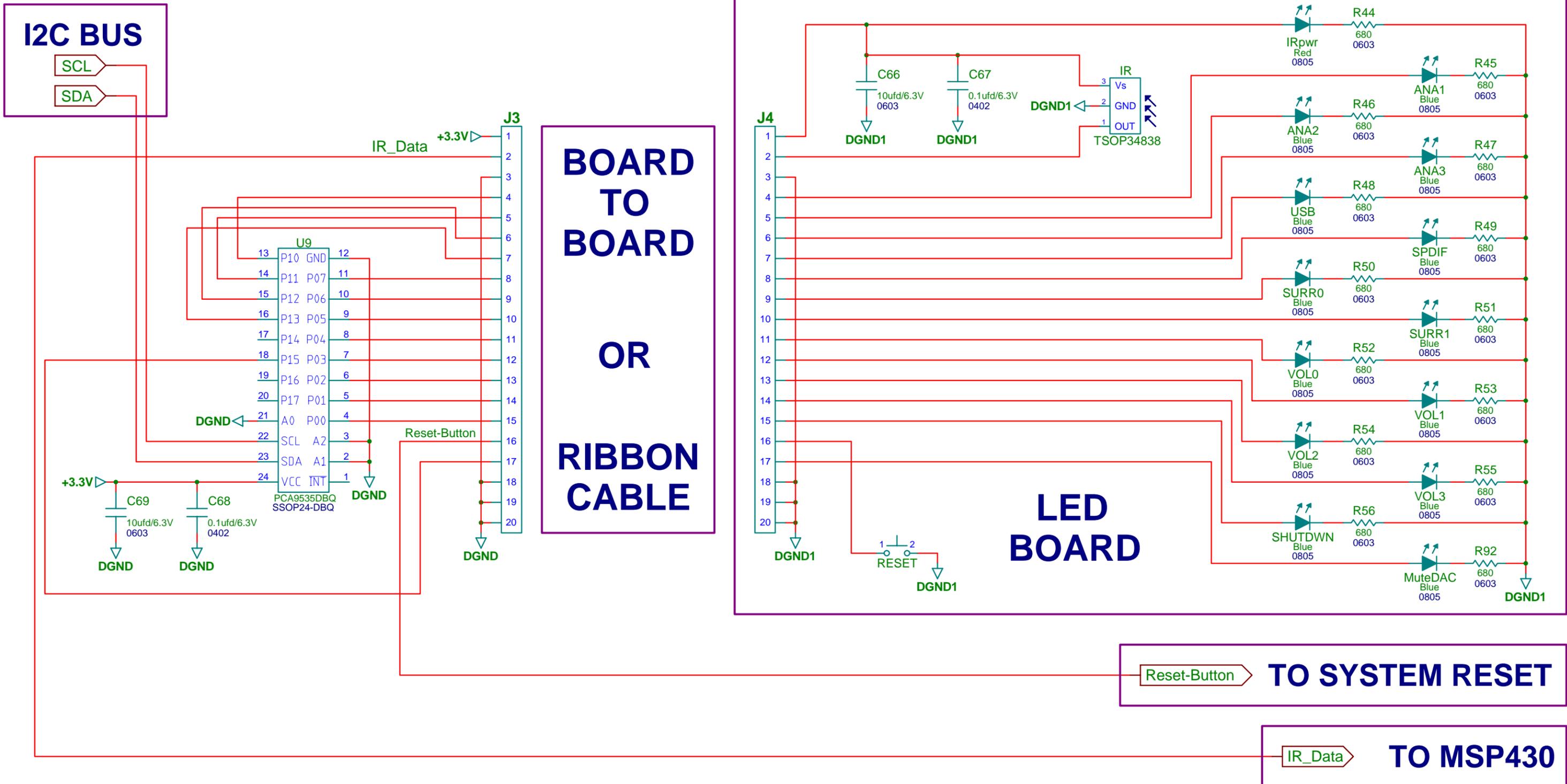
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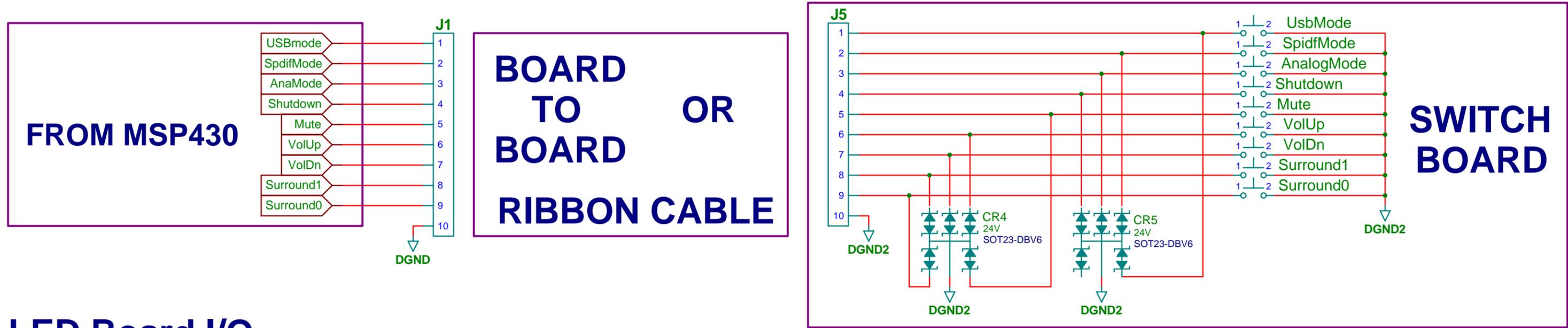
# RDK-Value-SB (RevA)



# RDK-Value-SB (RevA)

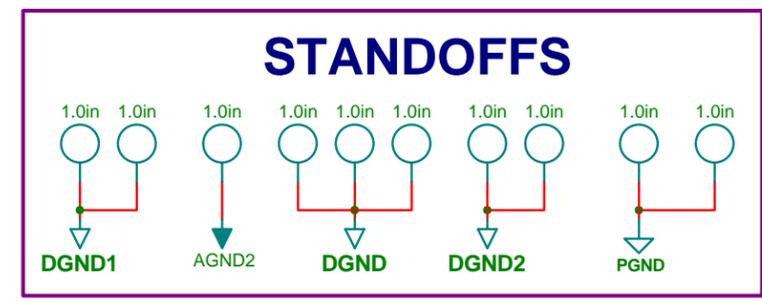
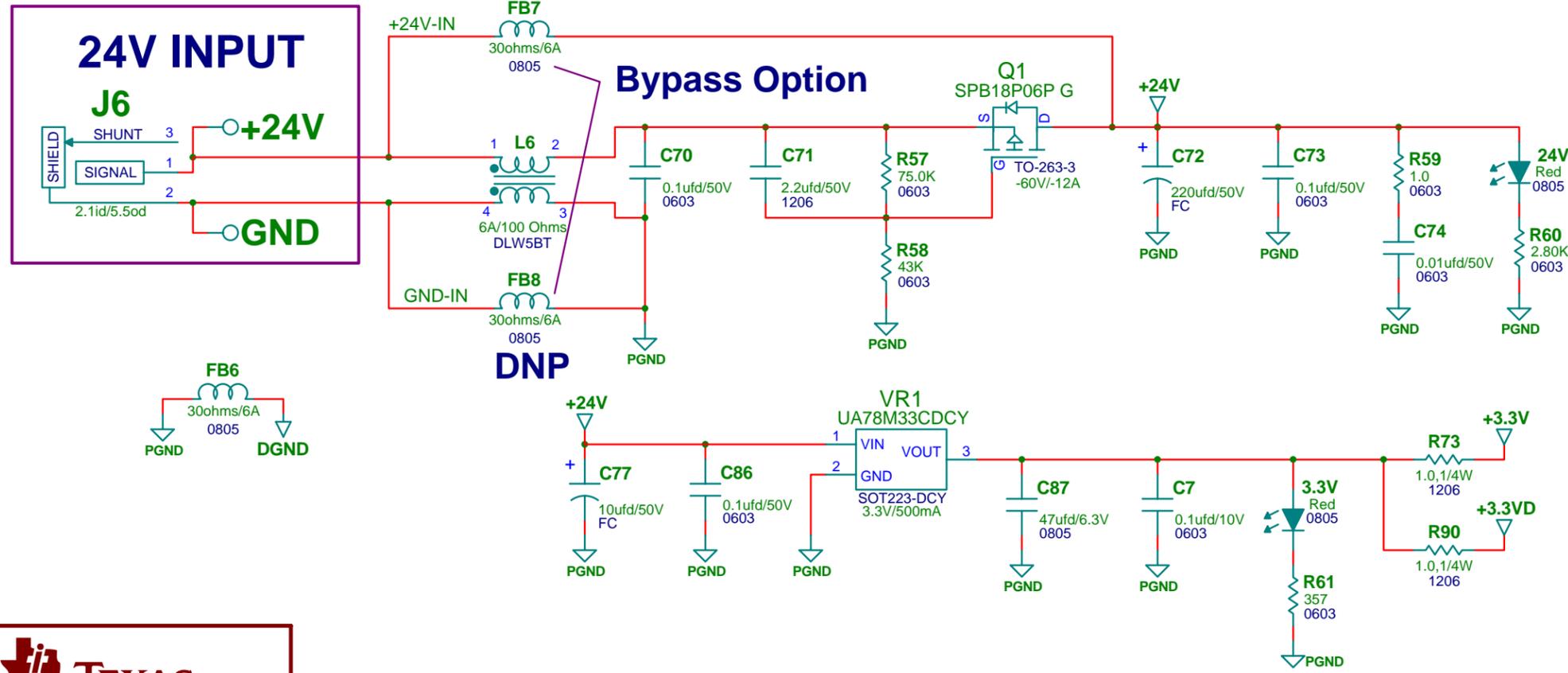


# RDK-Value-SB (RevA)



## LED Board I/O

## Power Supplies



## REVISION HISTORY

REVISION	DESCRIPTION	DATE	APPROVAL
A	INITIAL RELEASE	MARCH 23, 2011	HL

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